

13 12 11 10 9 8 7 6 5 4 3 2 1

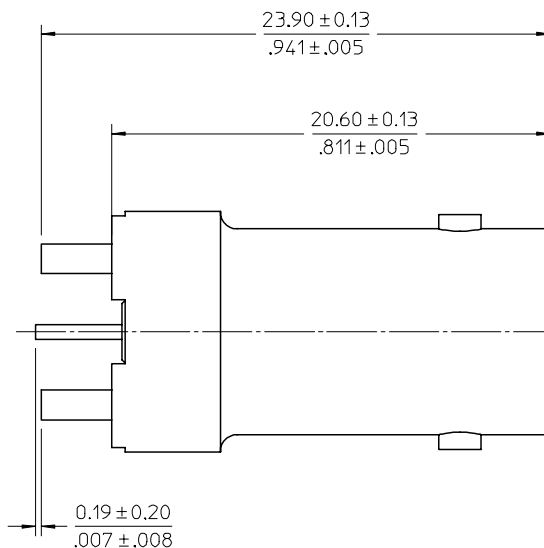
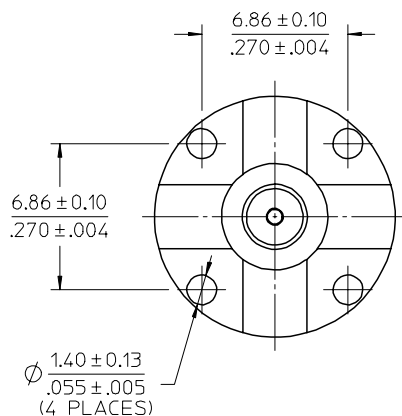
J

MATERIALS AND FINISHES

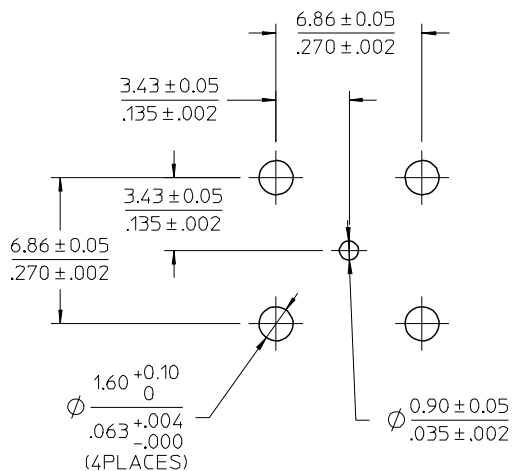
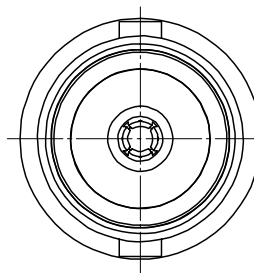
BODY ZINC ALLOY
PLATED NICKEL 70u" MIN

CENTER CONTACT
PHOSPHOR BRONZE
PLATED GOLD 30u" MIN

INSULATOR TEFLON



INTERFACE PER MOLEX
STANDARD ES-73599-0000



PCB HOLE CONFIGURATION

LOAD TO WM EC NO: URF-2008-0099 2007/08/17 DRAWN:CLLI CHKD: 2007/08/17 APPR: MHIANG 2007/08/17 REV	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM/IN		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
			mm	INCH	DRAWN BY	DATE	TITLE					
			4 PLACES	± ---	± ---	CLLI	05/07/02	BNC JACK VERTICAL PCB				
			3 PLACES	± ---	± ---	CHECKED BY	DATE	75 OHM				
			2 PLACES	± ---	± ---	BETTY	05/07/02	BNC-J/PCB				
			1 PLACE	± ---	± ---	APPROVED BY	DATE			MOLEX INCORPORATED		
			ANGULAR ± 2 °		MISEN	05/07/02						
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. 73101-0360		DOCUMENT NO. SD-73101-036				SHEET NO. 1 OF 1	
			SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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